

[54] HEADPHONE

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[73] Assignee: Sony Corporation, Tokyo, Japan

[**] Term: 14 Years

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[30] Foreign Application Priority Data

Jul. 25, 1984 [JP] Japan 59-31061

[52] U.S. Cl. D14/36

[58] Field of Search D14/1-7,
D14/36, 68, 69, 85, 95, 99; 381/25, 158, 183,
187; 379/430, 444; 181/129, 136, 137

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Headphones.

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[57] CLAIM

The ornamental design for a headphone, as shown.

DESCRIPTION

FIG. 1 is a front and right-side perspective view of a
headphone showing my new design;
FIG. 2 is a front elevational view thereof;
FIG. 3 is a rear elevational view thereof;
FIG. 4 is a left-side elevational view thereof;
FIG. 5 is a right-side elevational view thereof;
FIG. 6 is a top plan view thereof; and
FIG. 7 is a bottom plan view thereof.

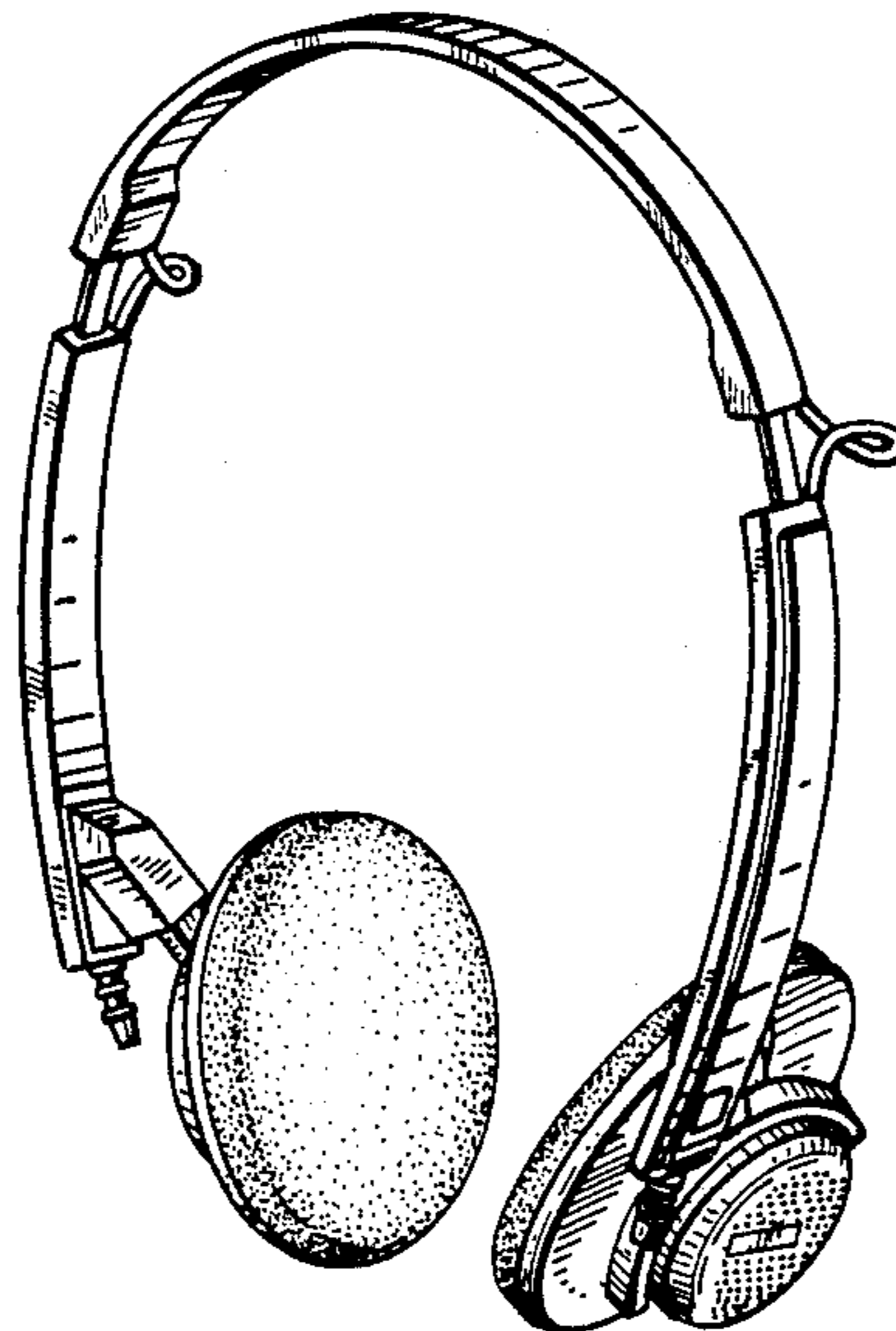


FIG. 1

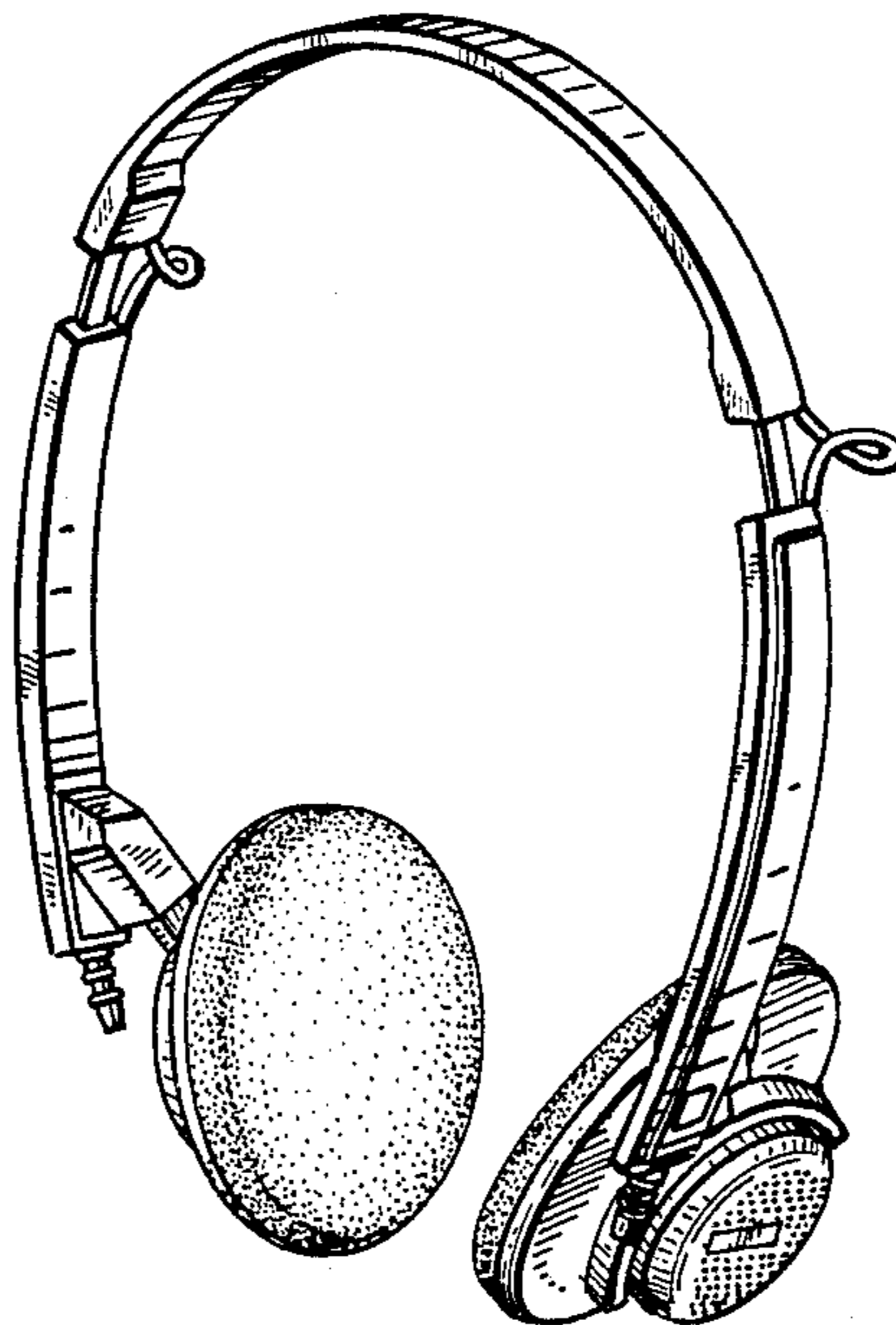


FIG. 2

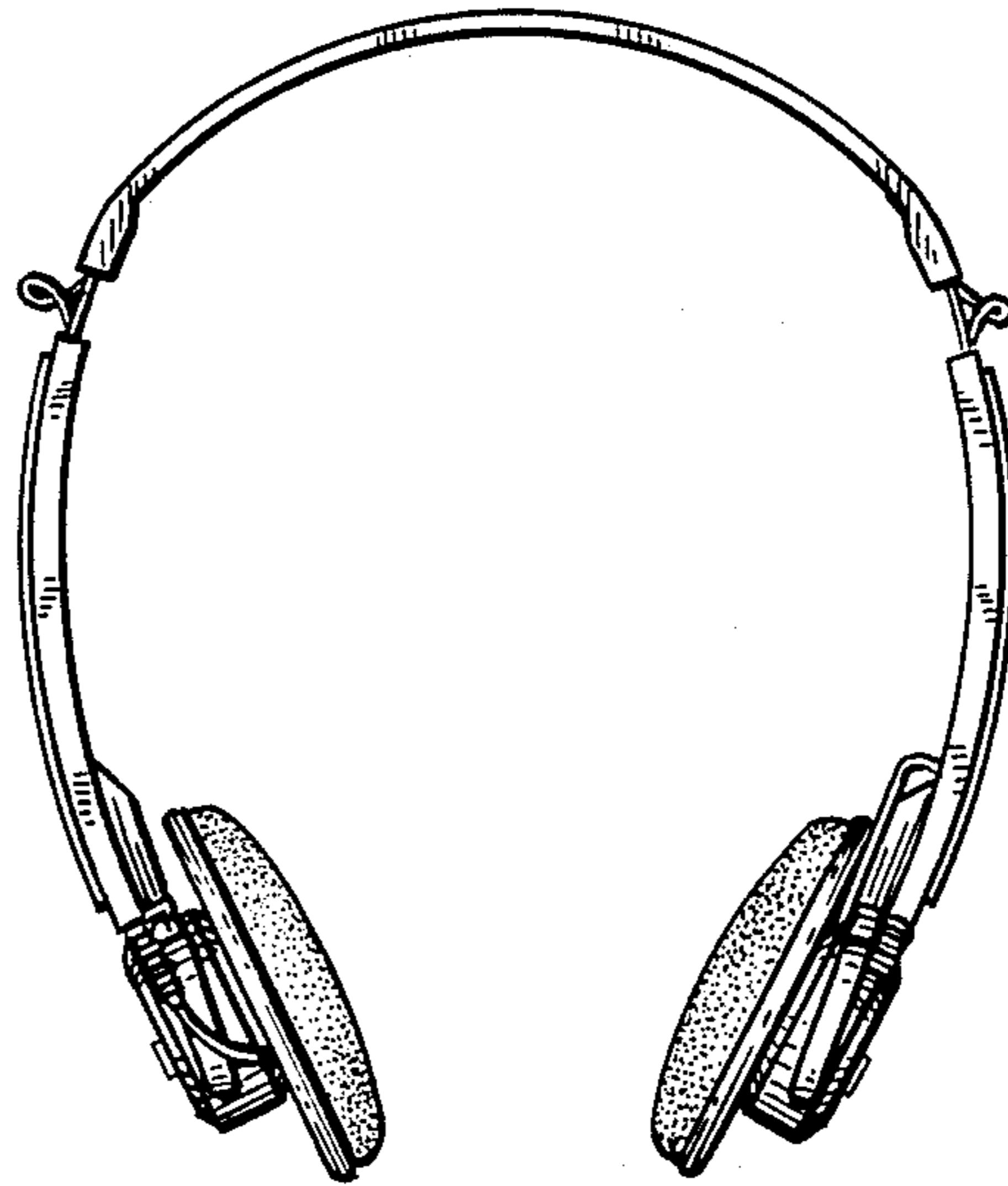


FIG. 3

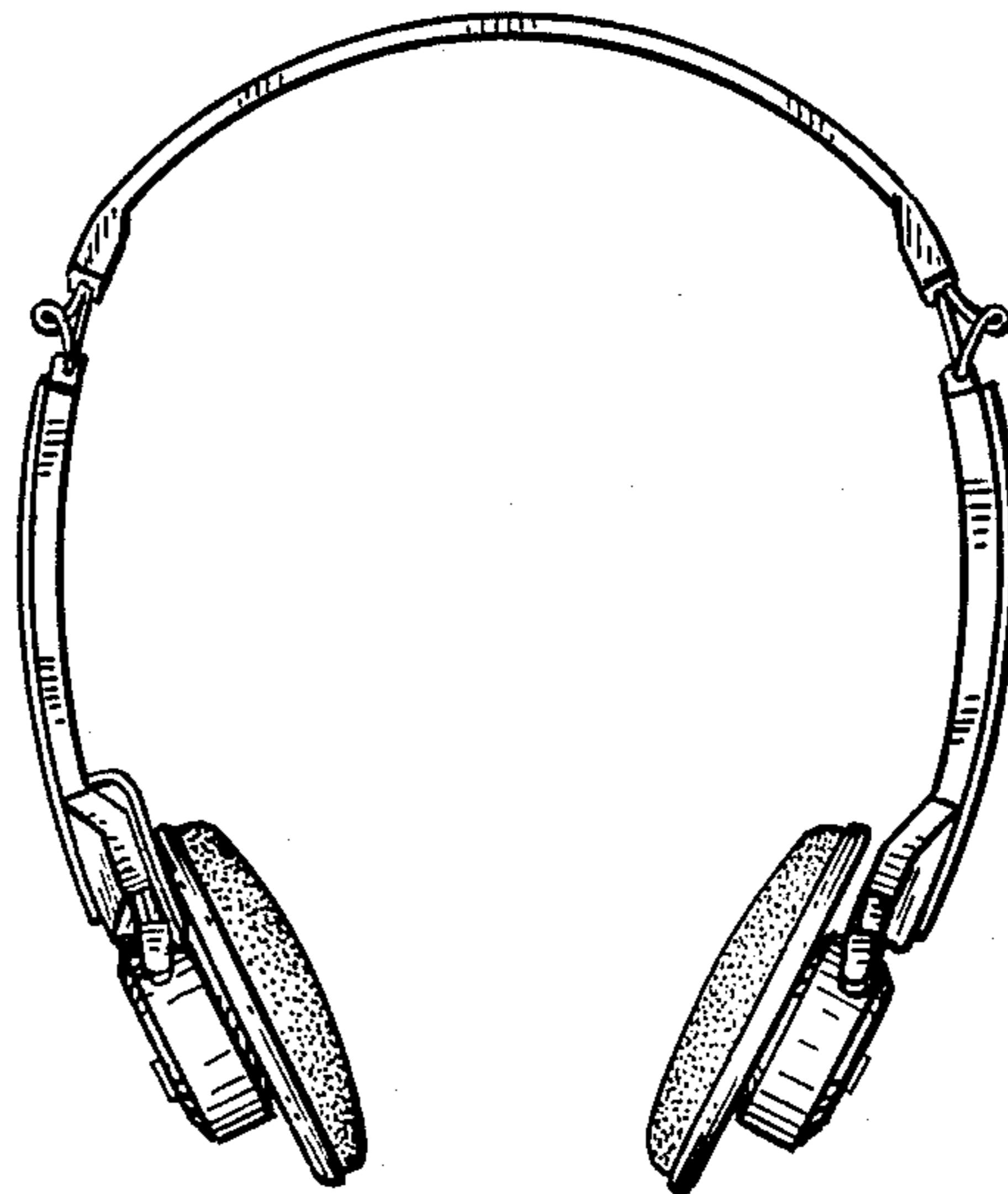


FIG. 4

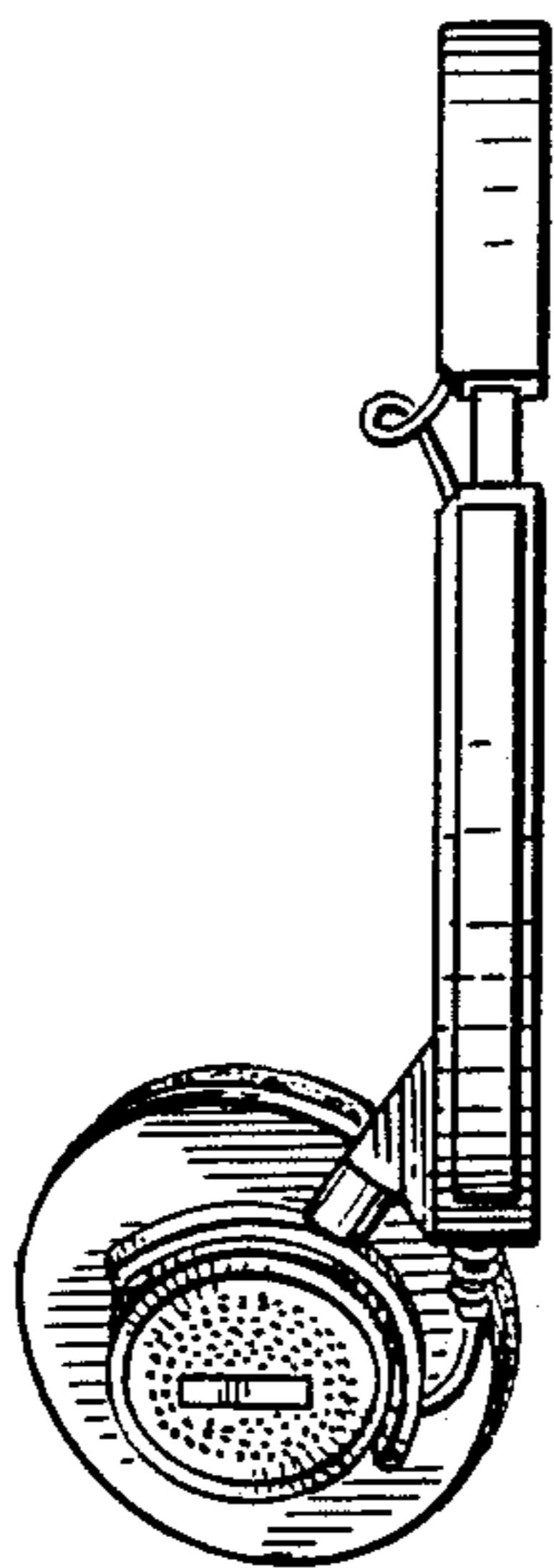


FIG. 5

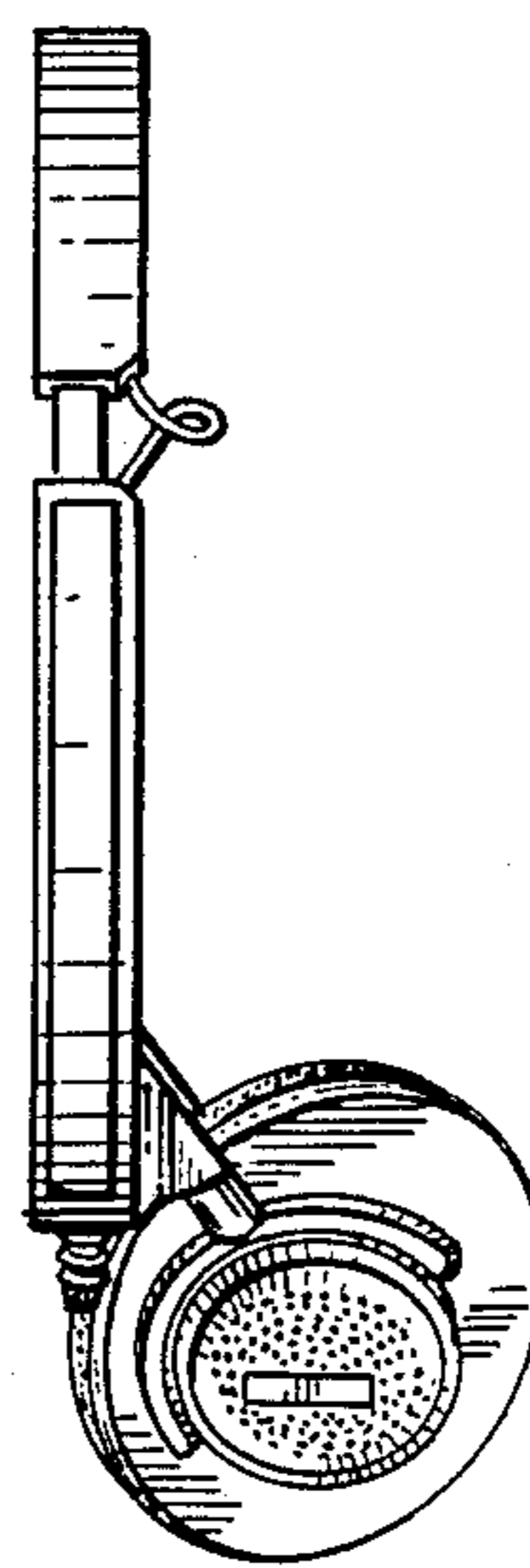


FIG. 6

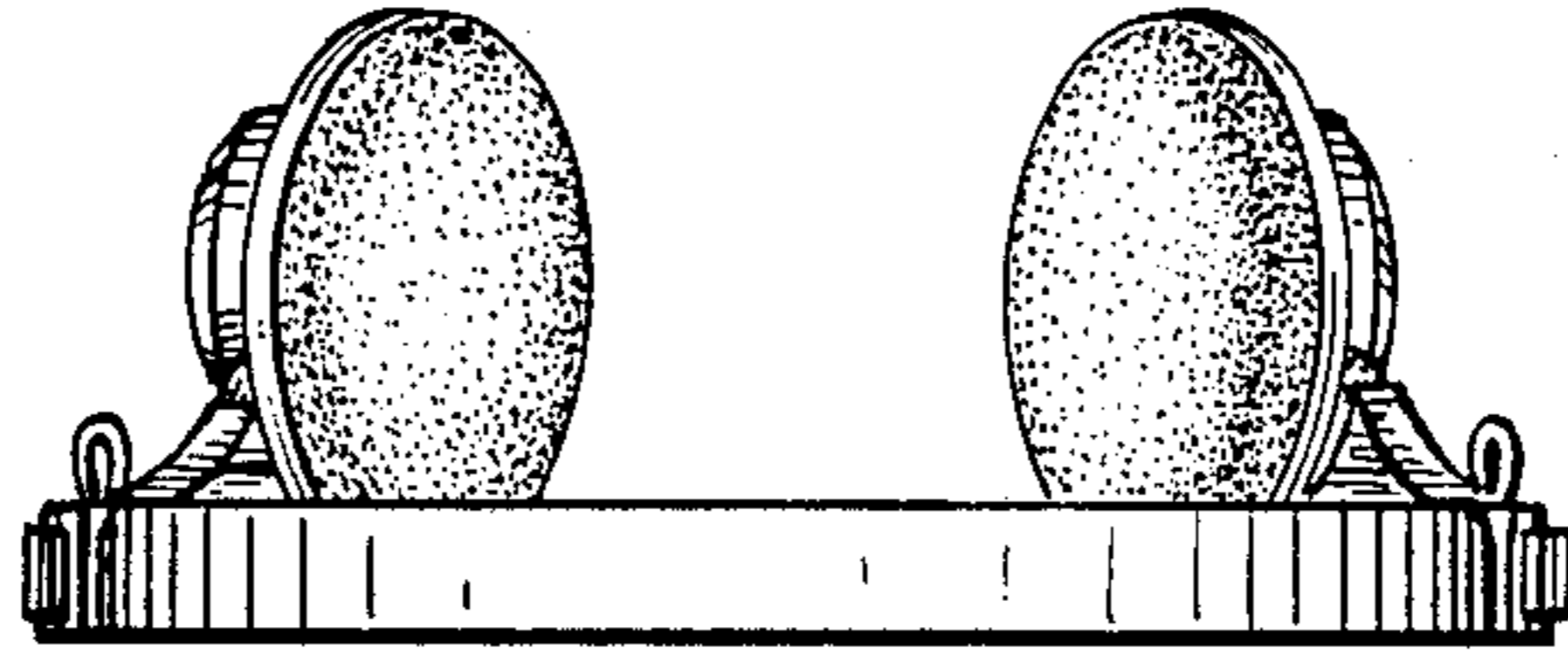


FIG. 7

